Ordering number : ENA0503A

SANYO Semiconductors
DATA SHEET

An ON Semiconductor Company

CMOS IC

LC72725KV — RDS(RBDS) Demodulation IC

Overview

The LC72725KV is IC that implement the signal processing required by the European Broadcasting Union RDS (Radio Data System) standard and by the US NRSC (National Radio System Committee) RBDS (Radio Broadcast Data System) standard. This IC include band-pass filter, demodulator, and data buffer on chip. RDS data can be read out from this on-chip memory by external clock input in slave operation mode.

Functions

- Bandpass filter: Switched capacitor filter (SCF)
- RDS Demodulation: 57KHz carrier and RDS data clock regeneration, biphase decode, differential decode.
- Buffer: 128 bit (about 100ms) can be restored in the on-chip data buffer RAM.
- Data output: Master or slave output mode can be selected.
- RDS-ID: Detect RDS signal which can be reset by RST signal input.
- Standby control: Crystal oscillator can be stopped.
- Fully adjustment free
- Low Voltage

Specifications

Absolute Maximum Ratings at Ta = 25°C, $V_{SS}d = V_{SS}a = 0V$

Parameter	Symbol	Pin Name	Conditions	Ratings	Unit
Maximum supply voltage	V_{DD} max	$V_{DD}d$, $V_{DD}a$ *	$V_{DD}a \leq V_{DD}d+0.3V$	-0.3 to +6.5	V
Maximum input voltage	$V_{IN}1$ max	TEST, MODE, XIN, RDCL, RST		-0.3 to $V_{DD}d+0.3$	V
	$V_{IN}2$ max	MPXIN, CIN		-0.3 to $V_{DD}a+0.3$	V
Maximum output voltage	V_O1 max	RDS-ID(READY)		-0.3 to +6.5	V
	V_O2 max	XOUT, RDDA, RDCL		-0.3 to $V_{DD}d+0.3$	V
	V_O3 max	FLOUT		-0.3 to $V_{DD}a+0.3$	V
Maximum output current	I_O1 max	XOUT, FLOUT, RDDA, RDCL		+2.0	mA
	I_O2 max	RDS-ID(READY)		+8.0	mA

* $V_{DD}a \leq V_{DD}d+0.3V$

Continued on next page.

Continued from preceding page.

Parameter	Symbol	Pin Name	Conditions	Ratings	Unit
Allowable power dissipation	Pd max		Ta≤85°C	100	mW
Operating temperature	Topr1		V_{DD} = 2.7V to 5.5V	-20 to +70	°C
	Topr2		V_{DD} = 3.0V to 5.5V	-40 to +85	°C
Storage temperature	Tstg			-40 to +125	°C

Allowable Operating Ranges at Ta = -20 to +70°C, $V_{SS}d = V_{SS}a$ = 0V, $V_{DD}d = V_{DD}a$ = 2.7V to 5.5V

Ta = -40 to +85°C, $V_{SS}d = V_{SS}a$ = 0V, $V_{DD}d = V_{DD}a$ = 3.0V to 5.5V

Parameter	Symbol	Pin Name	Conditions	Ratings			unit
				min	typ	max	
Supply voltage	$V_{DD}1$	$V_{DD}d$, $V_{DD}a$	Ta = -20 to +70°C	2.7		5.5	V
	$V_{DD}2$	$V_{DD}d$, $V_{DD}a$	Ta = -40 to +85°C	3.0		5.5	
Input high-level voltage	$V_{IH}1$	TEST, MODE, RST		$0.7V_{DD}d$		6.5	V
	$V_{IH}2$	RDCL		$0.7V_{DD}d$		$V_{DD}d$	V
Input low-level voltage	V_{IL}	TEST, MODE, RST, RDCL		0		$0.3V_{DD}d$	V
Output voltage	V_O1	RDDA, RDCL				$V_{DD}d$	V
	V_O2	RDS-ID(READY)				6.5	V
Input amplitude	V_{IN}	MPXIN	f = 57±2kHz	1.6		50	mVrms
	VXIN	XIN		400		1500	mVrms
Guaranteed crystal oscillator frequencies	Xtal	XIN, XOUT	CI≤120Ω		4.332		MHz
Crystal oscillator operating range	TXtal	XIN, XOUT	Fo = 4.332MHz			±100	ppm
RDCL setup time	tCS	RDCL, RDDA		0			μs
RDCL high-level time	tCH	RDCL		0.75			μs
RDCL low-level time	tCL	RDCL		0.75			μs
Data output time	tDC	RDCL, RDDA				0.75	μs
READY output time	tRC	RDCL, READY				0.75	μs
READY low-level time	tRL	READY				107	ms

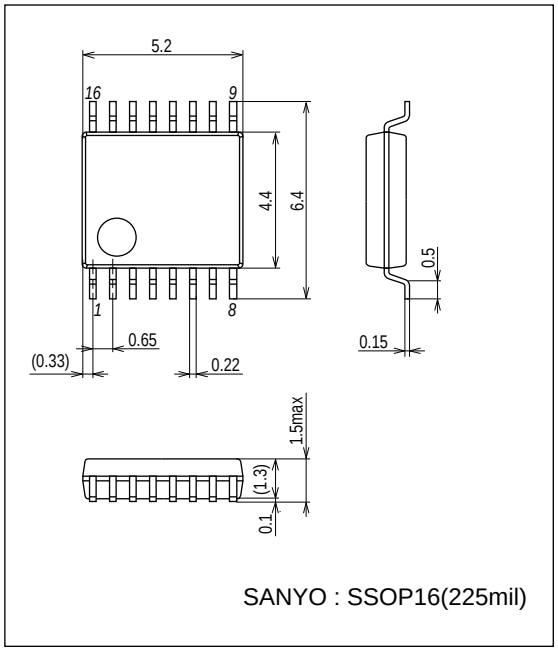
Electrical Characteristics for the Allowable Operating Ranges

Parameter	Symbol	Pin Name	Conditions	Ratings			unit
				min	typ	max	
Input resistance	Rmpxin	MPXIN-V_{SS}a	f = 57kHz		100		kΩ
	Rcin	CIN-V_{SS}a	f = 57kHz		100		kΩ
Internal feedback resistance	Rf	XIN			1.0		MΩ
Center frequency	fc	FLOUT		56.5	57.0	57.5	kHz
-3dB band width	BW-3dB	FLOUT		2.5	3.0	3.5	kHz
Gain	Gain	MPXIN-FLOUT	f = 57kHz	28	31	34	dB
Stop band attenuation	Att1	FLOUT	Δf = ±7kHz	30			dB
	Att2	FLOUT	F<45kHz, f>70kHz	40			dB
	Att3	FLOUT	F<20kHz	50			dB
Reference voltage output	Vref	Vref	V_{DD}a = 3V		1.5		V
Hysteresis	VHIS	TEST, MODE, RST, RDCL			0.1V_{DD}d		V
Output low-level voltage	V_{OL}1	RDDA, RDCL	I = 2mA			0.4	V
	V_{OL}2	RDS-ID(READY)	I = 8mA			0.4	V
Output high-level voltage	V_{OH}	RDDA, RDCL	I = 2mA	V_{DD}d-0.4			V
Input high-level current	I_{IH}1	TEST, MODE, RST, RDCL	V_I = 6.5V			5.0	μA
	I_{IH}2	XIN	V_I = V_{DD}d	2.0		11	μA
Input low-level current	I_{IL}1	TEST, MODE, RST, RDCL	V_I = 0V			5.0	μA
	I_{IL}2	XIN	V_I = 0V	2.0		11	μA
Output off leakage current	IOFF	RDS-ID(READY)	V_O = 6.5V			5.0	μA
Current drain	I_{DD}	V_{DD}d+V_{DD}a	V_{DD}d+V_{DD}a (V_{DD}d = V_{DD}a = 3V)		5		mA

Package Dimensions

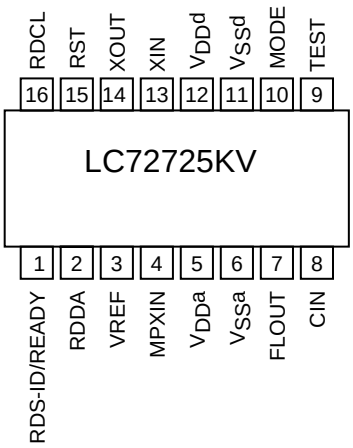
unit : mm (typ)

3178B



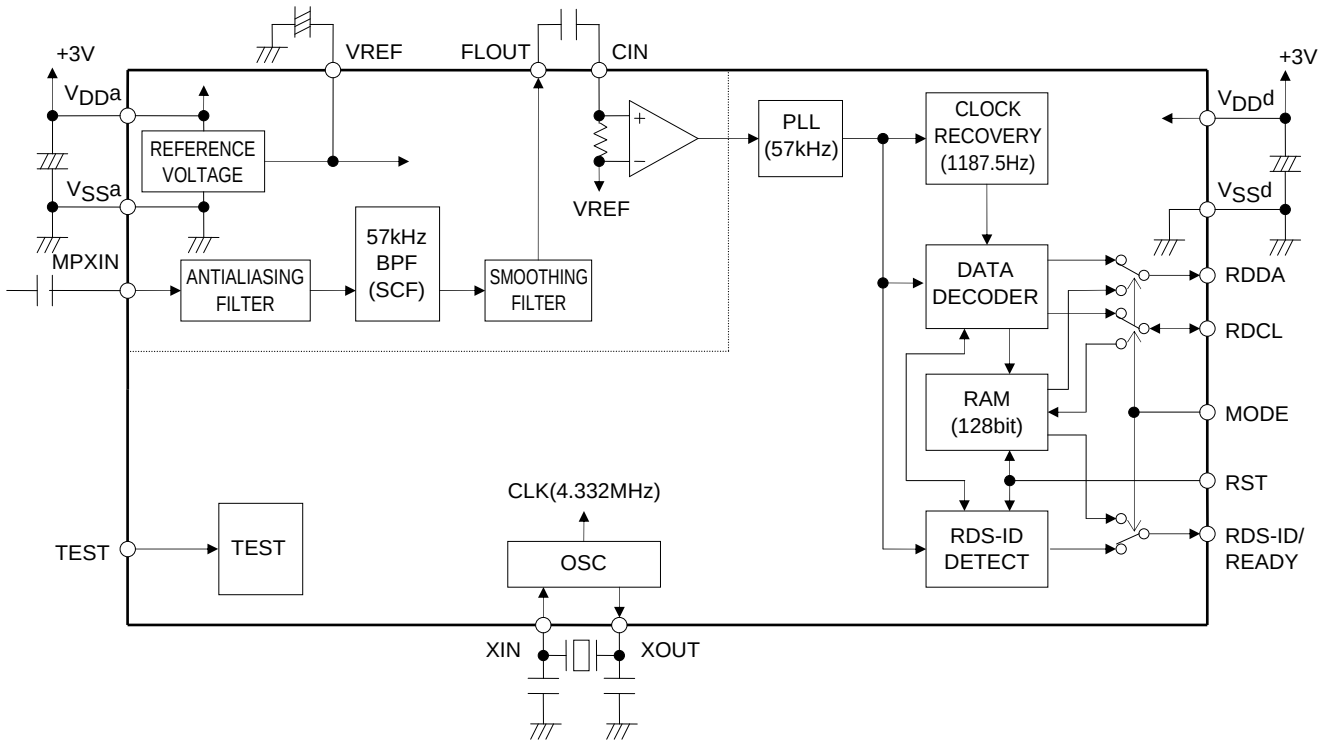
SANYO : SSOP16(225mil)

Pin Assignment

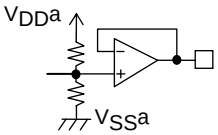
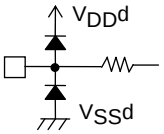
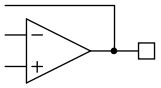
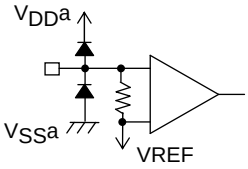
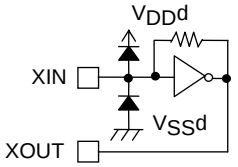
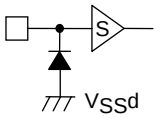
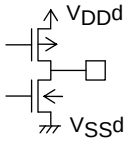
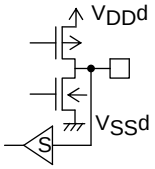
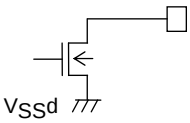


Top view

Block Diagram



Pin Descriptions

Pin No.	Pin Name	I/O	Function	Pin Circuit
3	VREF	Output	Reference voltage output (Vdda/2)	
4	MPXIN	Input	Baseband (multiplexed) signal input	
7	FLOUT	Output	Subcarrier output (filter output)	
8	CIN	Input	Subcarrier input (comparator input)	
5	$V_{DD}a$	-	Analog system power supply (+3V)	
6	$V_{SS}a$	-	Analog system ground	
14	XOUT	Output	Crystal oscillator output (4.332MHz)	
13	XIN	Input	Crystal oscillator input (external reference signal input)	
9	TEST		Test input	
10	MODE		Read out mode (0:master, 1:slave)	
15	RST		RDS-ID/RAM reset (active high)	
2	RDDA	Output	RDS data output	
16	RDCL	I/O	RDS clock output (master mode) / RDS read out clock input (slave mode)	
1	RDS-ID/ READY	Output	RDS reliability data output (High:data with high RDS reliability Low: data with low RDS reliability) READY output (active high)	
12	$V_{DD}d$	-	Digital system power supply (+3V)	
11	$V_{SS}d$	-	Digital system ground	

Input/Output Data Format

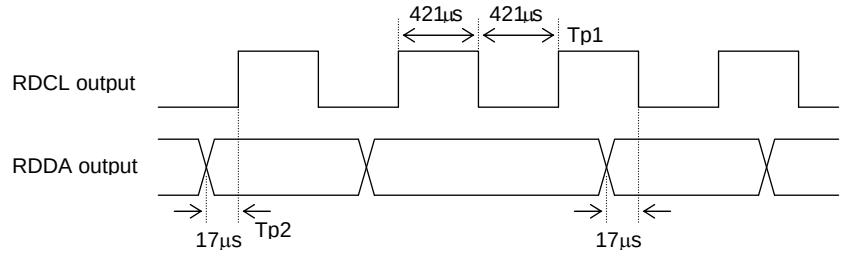
TEST	MODE	Circuit Operation Mode	RDCL Pin	RDS-ID/READY Pin
0	0	Master read out mode	Clock output	RDS-ID output
0	1	Slave read out mode	Clock input	READY output
1	0	Standby mode (crystal oscillator stopped)	-	-
1	1	IC test mode which is not available to user applications.	-	-

	RST Pin
RST = 0	Normal operation
RST = 1	RDS-ID • demodulation circuit clear + READY • memory clear (when slave mode)

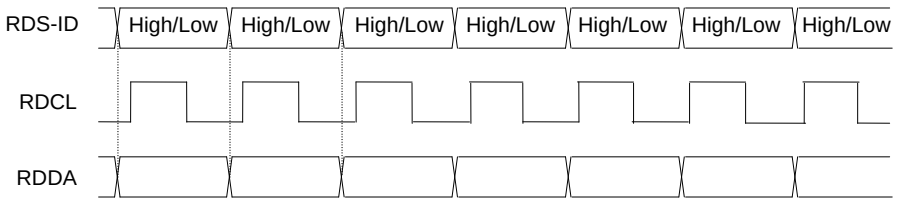
	RDS-ID/READY Pin
Master mode	RDS-ID output (Active-high)
Slave mode	READY output (Active-high)

Note: RDS-ID(READY) pin is an n-channel open-drain output, and requires an external pull-up resistor to output data.

RDCL/RDDA Output Timing in Master Mode

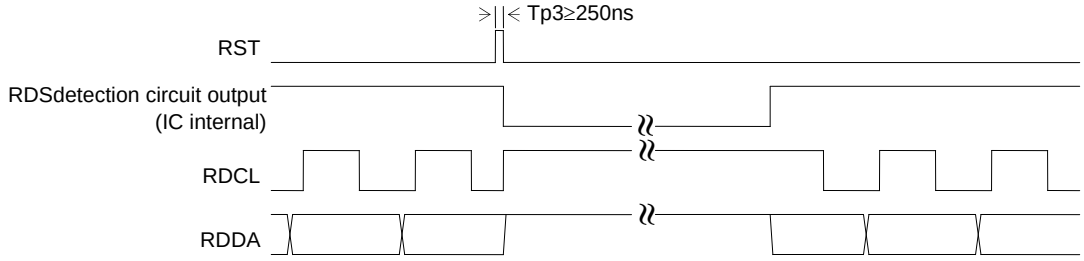


RDS-ID Output Timing



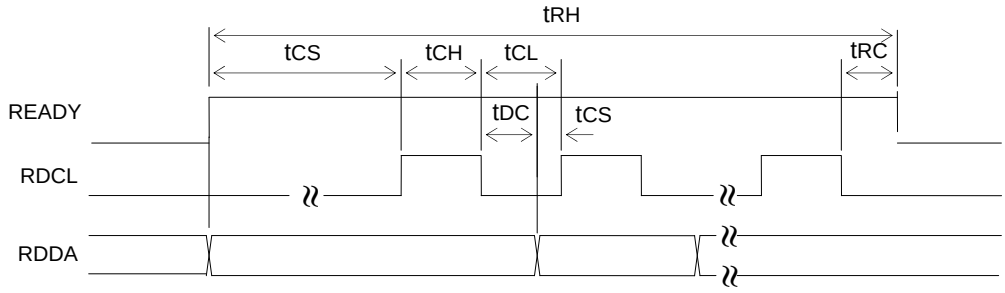
Note: RDS-ID is High: data with high RDS reliability, Low: data with low RDS reliability

RST Operation in Master Mode



Note: RDCL and RDDA outputs keep high level after input of RST until RDS detection circuit output is detected.

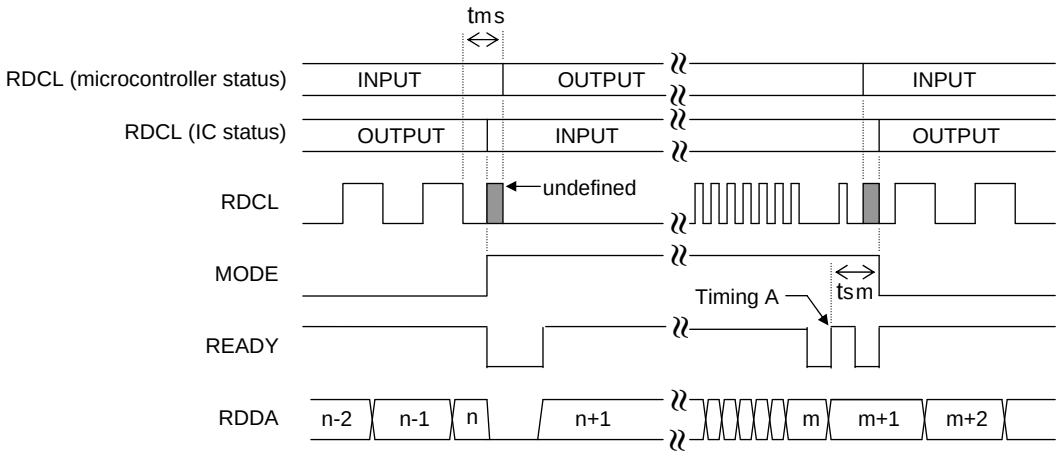
RDCL Operation in Slave Mode



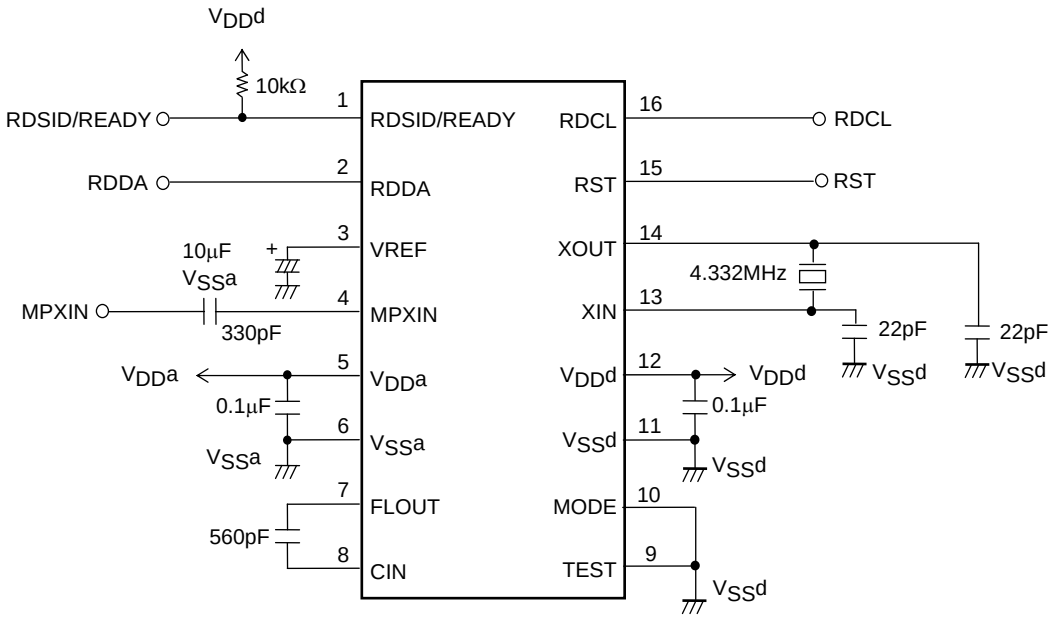
Parameter	Symbol	Pin Name	Conditions	Ratings			unit
				min	typ	max	
RDCL setup time	tCS	RDCL,RDDA		0			μs
RDCL high-level time	tCH	RDCL		0.75			μs
RDCL low-level time	tCL	RDCL		0.75			μs
Data output time	tDC	RDCL,RDDA				0.75	μs
READY output time	tRC	RDCL,READY				0.75	μs
READY high-level time	tRH	READY				107	ms

Notes: 1. RDCL input must be started after READY signal goes high. When READY signal is low, RDCL must be low level.

2. READY status must be checked after tRC time from RDCL is set low. If the READY status is high, then next read cycle can be continued. If the READY status is low, next RDCL clock input must be stopped.
3. If the above condition is satisfied, RDS data (RDDA) can be read out at both rising and falling edge of RDCL.
4. READY signal goes low after the last data is read out from on-chip memory. If one RDS data is stored in the memory, READY signal goes high again.
5. When the reception channel is changed, a memory and READY reset must be applied using RST input. If a reset is not applied, reception data from the previous channel may remain in memory. If RST input is applied, reception data is not stored in memory until the first RDS-ID is detected, and READY output goes high after the first RDS-ID is detected. After the first RDS-ID is detected, reception data is stored even if RDS-ID is not detected.
6. The readout mode may be switched between master and slave modes during readout.
   Applications must observe the following points to assure data continuity during this operation.
   1) Data acquisition timing in master made
      Data must be read on the falling edge of RDCL
   2) Timing of the switch from master mode to slave mode
      After the RDCL output goes low and the RDDA data has been acquired, the application must set MODE high immediately.
      Then, the microcontroller starts output by setting the RDCL signal low.
      The microcontroller RDCL output must start within 840μs (tms) after RDCL went low.
      In this case, if the last data read in master mode was data item n, then data starting with item n+1 will be written to memory.
   3) Timing of the switch from slave mode to master mode
      After all data has been read from memory and READY has gone high, the application must then wait until READY goes low once again the next time (timing A in the figure), immediately read out one bit of data and input the RDCL clock.
      Then, at the point READY goes high, the microcontroller must terminate RDCL output and then set MODE low.
      The application must switch MODE to low within 840μs (tms) after READY goes low (timing A in the figure).



Sample Application Connection Circuit (for master mode operation)



Note: If the RST pin is unused, it must be connected to ground.

Стандарт Электрон Связь

Мы молодая и активно развивающаяся компания в области поставок электронных компонентов. Мы поставляем электронные компоненты отечественного и импортного производства напрямую от производителей и с крупнейших складов мира.

Благодаря сотрудничеству с мировыми поставщиками мы осуществляем комплексные и плановые поставки широчайшего спектра электронных компонентов.

Собственная эффективная логистика и склад в обеспечивает надежную поставку продукции в точно указанные сроки по всей России.

Мы осуществляем техническую поддержку нашим клиентам и предпродажную проверку качества продукции. На все поставляемые продукты мы предоставляем гарантию .

Осуществляем поставки продукции под контролем ВП МО РФ на предприятия военно-промышленного комплекса России , а также работаем в рамках 275 ФЗ с открытием отдельных счетов в уполномоченном банке. Система менеджмента качества компании соответствует требованиям ГОСТ ISO 9001.

Минимальные сроки поставки, гибкие цены, неограниченный ассортимент и индивидуальный подход к клиентам являются основой для выстраивания долгосрочного и эффективного сотрудничества с предприятиями радиоэлектронной промышленности, предприятиями ВПК и научно-исследовательскими институтами России.

С нами вы становитесь еще успешнее!

Наши контакты:

Телефон: +7 812 627 14 35

Электронная почта: sales@st-electron.ru

Адрес: 198099, Санкт-Петербург, Промышленная ул, дом № 19, литера Н, помещение 100-Н Офис 331